Mirror Mezz Connectors

molex

Footprint-compatible Hermaphroditic Mirror Mezz connector lowers application costs with stackable mating to support data speeds up to 56 Gbps per differential pair for telecommunications, networking and other applications

Features and Benefits

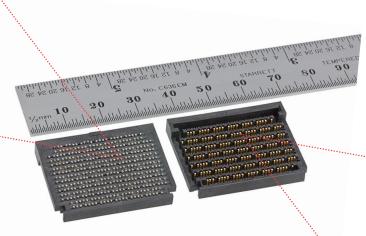


Hermaphroditic Mirror Mezz Connectors in 2.50 and 5.50mm (prototype only) height configurations (Remark: Picture on the right shows a 2.50mm connector mated to the 5.50mm version)



Stitched BGA design

Offers more cost savings than insert-molded BGA attachments. Stitched contact structure reduces lead-times and the connector design allows for simplified product matrix



Bottom (left) and top-side (right) perspectives of the 2.50mm height Mirror Mezz Connector

Intricately designed terminal structure

Provides numerous mechanical strengths while also benefiting from cutting-edge electrical features for some of the faster speeds in the industry



Applications

Data/Computing

Server

Networking

Storage

Telecommunications/Networking

Infrastructure

Networking



Storage



Networking

Mirror Mezz Connectors



Specifications

REFERENCE INFORMATION

Reference Information Packaging: Tape and Reel

Mates With: 2.50 and 5.50mm height connectors

can self- or cross-mate. Designed In: Millimeters

RoHS: Yes Halogen Free: Yes Glow Wire Compliant: NA

ELECTRICAL

Voltage (max.): 30V AC Current (max.): 1A per contact Low Level Contact Resistance (max. initial): 30 milliohm for 5mm stack height Dielectric Withstanding Voltage: 500V DC

Insulation Resistance: 1000 Megohm

Impedance: 92 ohms

MECHANICAL

Average Mating Force: 0.5N per pin (max.) Unmating Force: 0.045N per pin (min.) Contact Normal Force (min.): 0.2N per pin

Durability (max.): 100 cycles

PHYSICAL

Housing: High Temperature Thermoplastic, UL94-V0 Contact: High Performance Copper Alloy

Plating: Selective Gold

Contact Area — 0.76 micron Gold (Au) Solder Tail Area — 2.54 micron Tin (Sn) Underplating — 1.27 micron Nickel (Ni) Operating Temperature: -55 to 105°C

Ordering Information

Series No.	No. of rows	No. of differential pairs per row in Zone 1, 2 and 3	Total No. of differential pairs (excluding orphan pair)	Total No. of orphan pairs	Dimension
202828			Refer to Sales Drawings		